



MAS-FIN-153

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By: 

Date: October 17, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/090,289 Confirmation No. 6619  
Applicant : Johann Winderl  
Filed : March 4, 2002  
TC/A.U. : 2827  
Examiner : Luan C. Thai  
Title : Electric Component with Stacked Semiconductor Chips  
  
Docket No. : MAS-FIN-153  
Customer No. : 24131

Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

S i r :

In response to the Office action dated July 25, 2003, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.

An **Appendix** including a certified English translation of German Priority Application 101 10 203.8 is attached following page 13 of this paper.